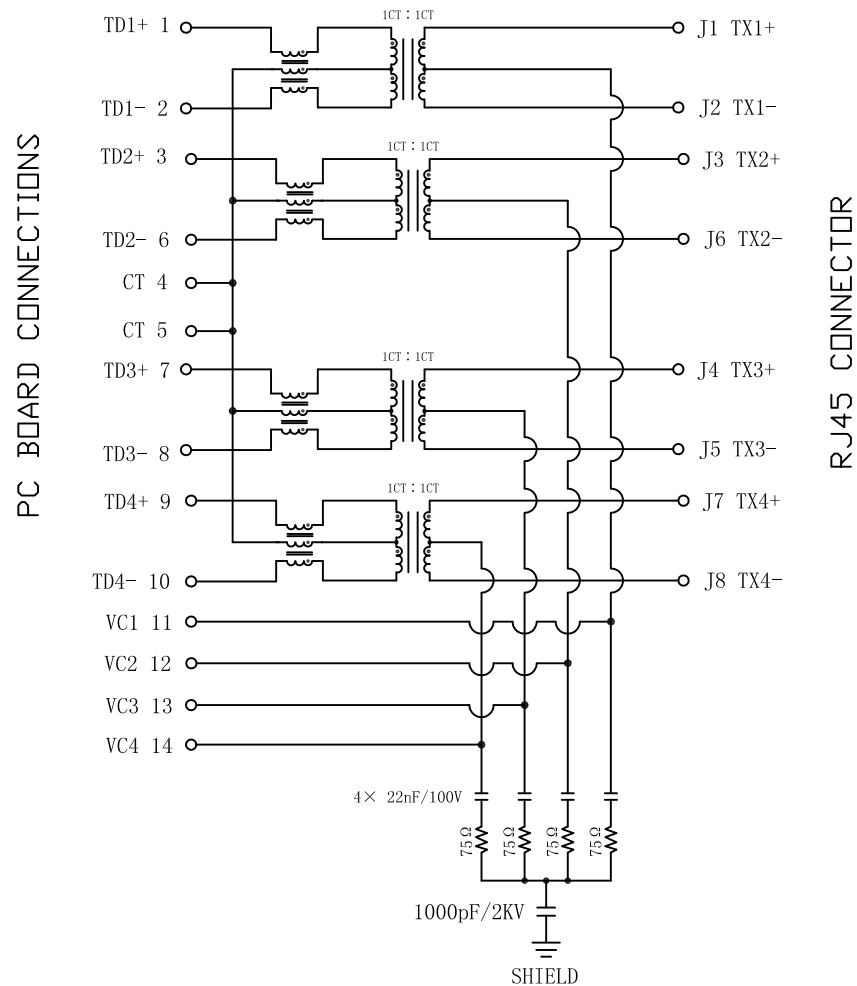


Schematic:

REV.	ECN NO.	DESCRIPTION	DATE	APPD
A	REL		2021-08-16	



ELECTRICAL SPECIFICATIONS @25°C

- Turn Ratio($\pm 2\%$):
Pri : Sec = 1CT : 1CT
- Inductance OCL:
180uH Min @100KHz, 0.1V, 8mADC Bias.
- Insertion Loss(dB Max):
1~50MHz:-0.5 50~125MHz:-1.0
- Return Loss(dB Min):
1~40MHz:-20
40~200MHz:-20+15*LOG₁₀(f/40)
- Cross talk(dB Min):
1~125MHz:-30
- Common Mode Rejection Ratio(dB Min):
30~200MHz:-30
- Common to Diff Rejection Ratio(dB Min):
10~125MHz:-45+f/35
- DC Current/Voltage Rating pse Pins:
720mA Max @57VDC(Continuous)
- Hipot Test: 1500Vrms Min
- Operating Temperature: 0°C~70°C.

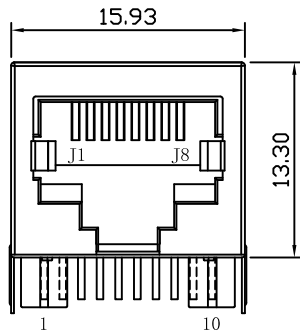
RoHS
2011/65/EU



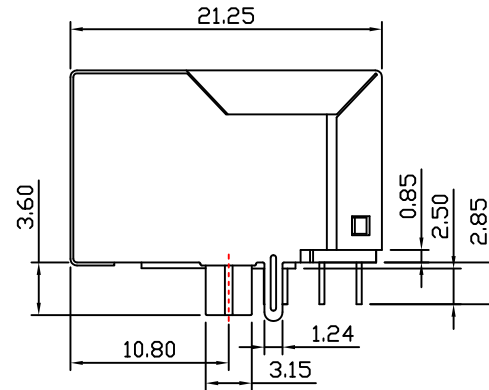
X:X	± 0.30	APPD:	LINK-PP INT'L TECHNOLOGY CO., LIMITED	
X:XX	± 0.25	CHKD:		
X:XXX	± 0.05	DR: TOM	TITLE: RJ45 Connector with 2.5G Base-T Integrated Magnetics For PoE+ Application	
ANGLES	$\pm 1^\circ$	UNIT: mm	PART NO.: LPJM05125DNL	
	SCALE: 2/1	SHEET: 1/2	REV: A	DWG NO.: LP21081601

Mechanical:

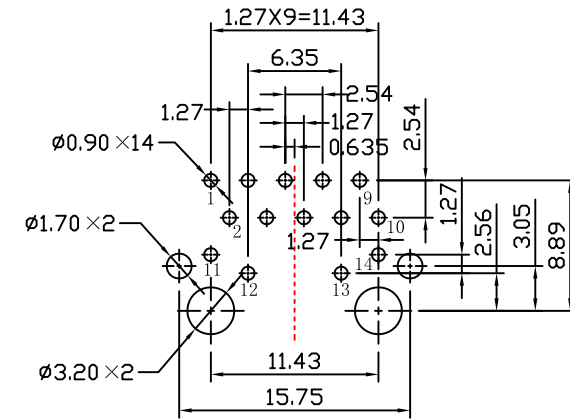
REV.	ECN NO.	DESCRIPTION	DATE	APPD
A	REL		2021-08-16	



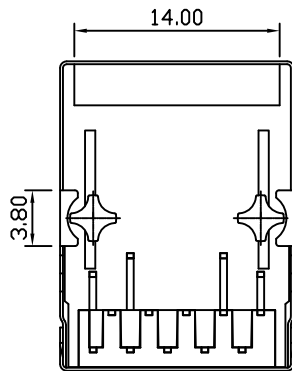
Front Side View



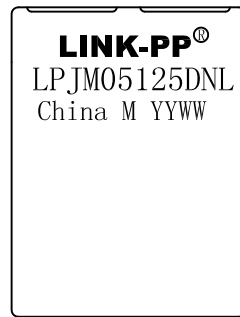
Left Side View



Suggested PCB Layout (Top View)



Bottom Side View



Top Side View



NOTES:

1. Designed to support application, such as SOHO (ADSL modems), LAN-on-Motherboard (LOM), hub and Switches.
2. Meets IEEE802.3at specification.
3. Connector Materials:
Housing: Thermoplastic PBT+30%G.F UL94V-0
Contact: Phosphor Bronze C5210R-EH Thickness=0.35mm
Pins: Brass C2680R-H Thickness=0.35mm
Shield: SUS 201-1/2H Thickness=0.2mm
Contact plating: Gold 6 micro-inches min. In contact area.
4. Wave solder tip temperature: 250°C, 5 Sec.
5. UL Certification: File Number E484635.

X:X ±0.30		APPD:		LINK-PP INT'L TECHNOLOGY CO., LIMITED		
X:XX ±0.25		CHKD:				
X:XXX ±0.05		DR: TOM		TITLE: RJ45 Connector with 2.5G Base-T Integrated Magnetics For PoE+ Application		
ANGLES ±1°		UNIT: mm				
			SCALE: 2/1	SHEET: 2/2	REV: A	DWG NO. : LP21081601